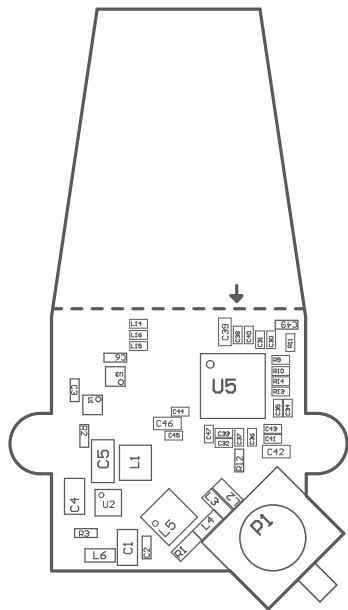


ZZ1 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

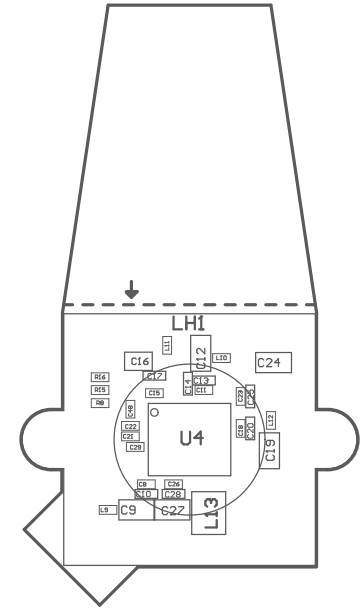
ZZ2 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

| | | | |
|----------------------------------|-----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: TIDA-01130 | REV: E3 | SUN REV: Not In VersionControl |
| IGNORE -> | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 10/31/2017 4:30:02 PM | TEXAS INSTRUMENTS | |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|-------------------------------------|-----------------------------------|---------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: TIDA-01130 | REV: E3 | SUN REV: Not In VersionControl |
| IGNORE -> | | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 10/31/2017 4:30:02 PM | | TEXAS INSTRUMENTS |

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